

SN54LS31, SN74LS31 DELAY ELEMENTS

SDLS157 – DECEMBER 1983 – REVISED MARCH 1988

- Delay Elements for Generating Delay Lines
- Inverting and Non-inverting Elements
- Buffer NAND Elements Rated at I_{OL} of 12/24 mA
- PNP Inputs Reduce Fan-In ($I_{IL} = -0.2$ mA MAX)
- Worst Case MIN/MAX Delays Guaranteed Across Temperature and V_{CC} Ranges

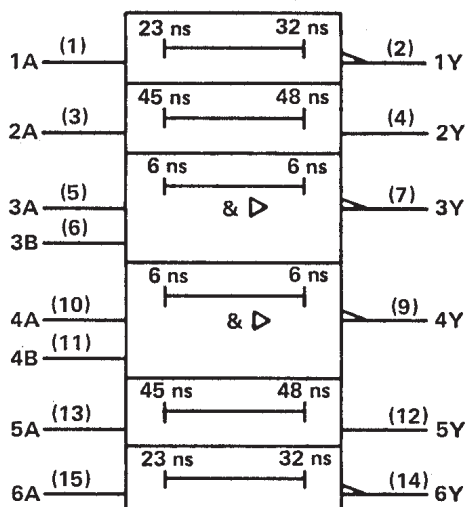
description

These 'LS31 delay elements are intended to provide well-defined delays across both temperature and V_{CC} ranges. Used in cascade, a limitless range of delay gating is possible.

All inputs are PNP with I_{IL} MAX of -0.2 mA. Gates 1, 2, 5, and 6 have standard Low-Power Schottky output sink current capability of 4 and 8 mA I_{OL} . Buffers 3 and 4 are rated at 12 and 24 mA.

The SN54LS31 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LS31 is characterized for operation from 0°C to 70°C .

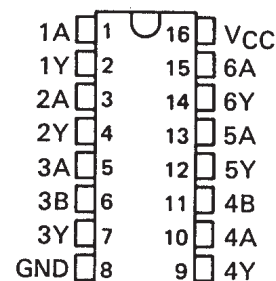
logic symbol†



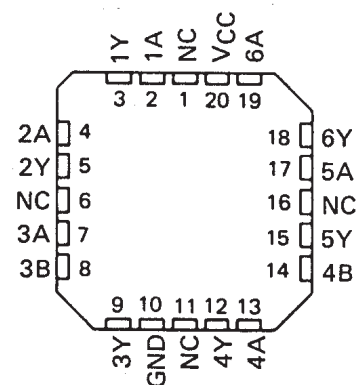
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54LS31 . . . J OR W PACKAGE
SN74LS31 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS31 . . . FK PACKAGE
(TOP VIEW)

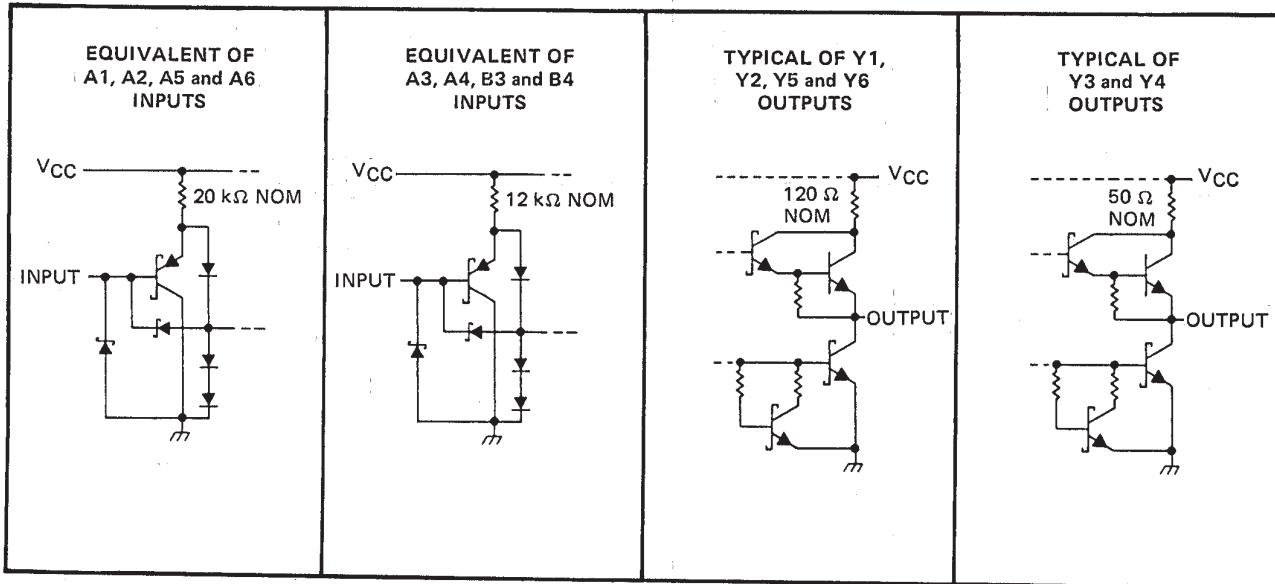


NC - No internal connection

SN54LS31, SN74LS31 DELAY ELEMENTS

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Delay Element	Logic	Typical Delays			Rated I _{OL}
		t _{PLH}	t _{PHL}	AVG.	
Gates 1 and 6	Inverting	32 ns	23 ns	27.5 ns	4 and 8 mA
Gates 2 and 5	Non-Inverting	45 ns	48 ns	46.5 ns	4 and 8 mA
Buffers 3 and 4	2-Input NAND	6 ns	6 ns	6 ns	12 and 24 mA



absolute maximum ratings over operating free air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (See Note 1)	7 V
Input voltage, V _I : All inputs	7 V
Operating free-air temperature range: SN54LS31	– 55°C to 125°C
SN74LS31	0°C to 70°C
Storage temperature range	– 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54LS31			SN74LS31			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.7			0.8	V
I _{OH} High-level output current	Y3, Y4 outputs		– 1.2	Y3, Y4 outputs		– 1.2	mA
	All other outputs		– 0.4	All other outputs		– 0.4	
I _{OL} Low-level output current	Y3, Y4 outputs		12	Y3, Y4 outputs		24	mA
	All other outputs		4	All other outputs		8	
T _A Operating free-air temperature	– 55	125		0	70		°C



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54LS31			SN74LS31			UNIT	
			MIN	TYP‡	MAX	MIN	TYP‡	MAX		
V _{IK}	V _{CC} = MIN, I _I = -18 mA		-1.5			-1.5			V	
V _{OH}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	Y3, Y4	I _{OH} = -1.2 mA			2.4 3.1			V	
		Others	I _{OH} = -0.4 mA			2.5 3.1				
V _{OL}	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	Y3, Y4	I _{OL} = 12 mA			0.25 0.4			V	
			I _{OL} = 24 mA			0.35 0.5				
		Others	I _{OL} = 4 mA			0.25 0.4				
			I _{OL} = 8 mA			0.35 0.5				
I _I	V _{CC} = MAX, V _I = 7 V		0.1			0.1			mA	
I _{IH}	V _{CC} = MAX, V _I = 2.7 V		20			20			μA	
I _{IL}	V _{CC} = MAX, V _I = 0.4 V		-0.2			-0.2			mA	
I _{OS} §	V _{CC} = MAX, A3, A4, B3, B4 = 0 V		Y3, Y4			-30 -130			mA	
	V _{CC} = MAX, A1, A6 = 0 V, A2, A5 = 4.5 V		Y1, Y2, Y5, Y6			-20 -100				
I _{CC}	I _{CC} H	V _{CC} = MAX, A2, A5 = 4.5 V, all other inputs 0 V		2.3 4			2.3 4			mA
	I _{CC} L	V _{CC} = MAX, A2, A5 = 0 V, all other inputs 4.5 V		13 20			13 20			

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

switching characteristics, (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LS31			SN74LS31			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
t _{PLH}	A1, A6	Y1, Y6	15			22			ns
t _{PHL}			70			65			
t _{PLH}	A2, A5	Y2, Y5	9			13			ns
t _{PHL}			50			45			
t _{PLH}	A3, B3, A4, Y4	Y3, Y4	22			31			ns
t _{PHL}			90			80			
t _{PLH}	Y4	Y3, Y4	20			30			ns
t _{PHL}			105			95			
t _{PLH}	Y4	Y3, Y4	2			2			ns
t _{PHL}			20			15			
t _{PHL}	Y4	Y3, Y4	2			2			ns
t _{PHL}			20			15			

NOTE 2: V_{CC} = MIN to MAX

R_L = 667 Ω, C_L = 45 pF for Y3 and Y4.

R_L = 2 kΩ, C_L = 15 pF for Y1, Y2, Y5 and Y6.

T_A = MIN to MAX

Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74LS31D	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS31
SN74LS31D.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS31
SN74LS31N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS31N
SN74LS31N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74LS31N
SN74LS31NSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS31
SN74LS31NSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS31

(1) Status: For more details on status, see our [product life cycle](#).

(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) RoHS values: Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS31NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS31NSR	SOP	NS	16	2000	353.0	353.0	32.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74LS31D	D	SOIC	16	40	507	8	3940	4.32
SN74LS31D.A	D	SOIC	16	40	507	8	3940	4.32
SN74LS31N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS31N	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS31N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74LS31N.A	N	PDIP	16	25	506	13.97	11230	4.32



PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER MASK DETAILS

4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

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